| | والتروي والمراب والمنافز والمراب والمنافز المسموس المنافز والماثر المنافز المنافز والمنافز وا | ويجدر المصافون متسديه بمعاملة وساعته ومعامله ومعامله | ه مسسمه سانوتان | والمرابط والمساورة والمرابط والمساور والمساورة | والواجمينة والمتحصيرة والمنط والمتحاليات جيباتها | | المعلا المناهل أراها المناهل ا | | | | |
|----------|--|--|---------------------------------|--|--|--|--|--|--|--|--|
| | | | TIMA | - A 80 | WER OF | | TTORNEY'S DOCKET NO.: PHNL010069 US | | | | |
| a | No weight | DELAR | SILIOM | ayno Pu | | SOS COS COS | 1 2 | | | | |
| •• | • | | | PATER 29 | `~\ | ORIGINALLY | TOPNEVIS DOCKET NO . | | | | |
| | | | | [3 · 8 | 2000 | - FILED | PHNL010069_US | | | | |
| ĩ | . As a below na | amed inventor, I hereby | declare tha | | | | | | | | |
| | My residence, | amed inventor, I nereby , post office address and the original, first and so | d citizenshi | p ale as state | d below next to my | y name. | ioint inventor (if plural | | | | |
| | I believe I am | the original, first and so v) of the subject matter v | ole inventor which is cla | (if only one for) | which a patent is s | v) or an onginal, illsi sought on the inventi | on entitled | | | | |
| | "Method of manufact | uring a semiconducto | r device ar | nd a semicon | ductor device ob | tained by means o | f said method" | | | | |
| | the specification of whi | ich (check one) | | | | | | | | | |
| | is attached hereto. | February 2002 | as A | onlication Se | rial No. 10/067 | 425 a | nd was amended on | | | | |
| | | | | | | | (if applicable). | | | | |
| | I hereby state | that I have reviewed ar | nd understa | ind the conten | its of the above-id | entified specification | , including the claims, as | | | | |
| | amended by the amend | dment(s) referred to about the duty to disclose in | ove. formation w | hich is materi | al to patentability | of this application in | accordance with Title 37, | | | | |
| 1 | Code of Federal Regul | lations, §1.56(a). | | | | | | | | | |
| | I hereby claim | foreign priority benefits | under Title | 35, United S | tates Code, § 119 | of any foreign appli | cation(s) for patent or | | | | |
| - 1 | inventor's certificate list | ted below and have also application on which pri | o identified iority is claii | med: | eign application ic | or patent or inventor | s certificate having a filing | | | | |
| | date before that or the | application on miles pro | PRIOR | FOREIGN A | PPLICATION(S) | | | | | | |
| Г | COUNTRY | APP. NUMBER | | DATE OF FI | LING | | PRIORITY CLAIMED | | | | |
| L | | | | (DATE, MON | | | UNDER 35 U.S.C. 119 | | | | |
| Ц | Europe | 01200496.6 | | 9 February | 2001 | P | YES | | | | |
| L | | | | | | | | | | | |
| | * I barabu alaina | the benefit under Title | 25 United | States Code | \$120 of any Unite | d States application | (s) listed below and, insofar | | | | |
| | as the subject matter of | of each of the claims of t | this applicat | tion is not disc | closed in the prior | United States applic | ation in the manner | | | | |
| - 1 | provided by the first pa | ragraph of Title 35 Unit | ed States C | Code, §112, I a | acknowledge the o | duty to disclose mate | erial information as defined | | | | |
| į | in Title 37, Code of Fed international filing date | deral Regulations, §1,56 | 6(a) which o | occurred betw | een the filing date | of the prior applicat | ion and the national or PCT | | | | |
| , | international hing date | | PRIOR UN | ITED STATE | S APPLICATION(| S) | | | | | |
| | APPLICATION SERIAL | | FILING D | | | | ATENTED, PENDING, | | | | |
| Ľ | AFFEIGATION SENIAL | LINOMBER | 1 12.1110 2 | 711 | | ABANDONE | | | | | |
| L | | | | | | | | | | | |
| _ | • | <u> </u> | <u> </u> | | | | | | | | |
| | I hereby decla | are that all statements n | nade herein | of my own kr | nowledge are true | and that all stateme | nts made on information | | | | |
| 3 | and belief are believed | to be true; and further | that these s | statements we | ere made with the | knowledge that willfu | ul false statements and the | | | | |
| - 1 | like so made are punis willful false statements | nable by fine or impriso may jeopardize the val | inment, or a lidity of the : | otn, under Se application or | anv patent issued | thereon. | ates Code and that such | | | | |
| | | • | | | | | | | | | |
| - | POWER OF ATTORNI | EY: As a named invente | or, I hereby | appoint the fo | ollowing attorney(s | s) and/or agent(s) to | prosecute this application | | | | |
| ŧ | and transact all busine | ss in the Patent and Tra | ademark Of | ffice connecte | d therewith. (list n | ame and registration | n number) | | | | |
| , | Jack E. Haken, Reg. N | lo. 26,902 | | | | | | | | | |
| | Michael E. Marion, Red Edward M. Blocker, Re | a. No. 32.266 | | | | | | | | | |
| Γ | | | | | | | | | | | |
| A | | ENCE TO: Corporate F | Patent Cour | nsel; | DIRECT TELEP (name and telep | HONE CALLS TO: | | | | | |
| П | U.S. Philips Corporatio | | | | (914) 332-0222 | | | | | | |
| Ŀ | 580 White Plains Road | l; Tarrytown, NY 10591 | | ··· | | ? | | | | | |
| <u> </u> | Detect | | | Inventor's Ci | mature: 7/ | | | | | | |
| | 13 March | 2002 | | mventor s Sig | Dated: Inventor's Signature: | | | | | | |
| | | | | | | | | | | | |
| 4 | | | | | | | | | | | |
| П | Full Name of Inventor | Last Name | | First Name | | Middle Name | - | | | | |
| L | Full Name of Inventor | Last Name VAN VEEN City | | First Name Nicolaas State or Fore | ign Country | Middle Name Johannes A | nthonius | | | | |

5656 AA Eindhoven Inventor's Signature:

State or Foreign Country
Th Netherlands

5656 AA Eindhoven

City

First Name

Marc

Zip Code

Zip Code

State or Country

Middle Name

State or Country

The Netherlands

Andre

Belgium

The Netherlands

Country of Citizenship

CONTRACTOR OF THE STATE OF THE

Citizenship

Residence &

Citizenship

Dated:

Post Office Address

Full Name of Inventor

Post Office Address

Last Name

Eindhoven

City

Str et

DE SAMBER

Prof. H Istlaan 6

Pr f. H Istlaan 6

Street

13 March 2002

Middle Name

State or Country

Country or Citizenship

Zip Code

| Dated: | | Inventor's Signature: | | |
|----------------------------|---------------------------|----------------------------------|-----------------------------------|----------|
| Full Name of Inventor | Last Name WEISS | First Name Thomas | Middle Name | |
| Residence & Citizenship | City Hamburg | State or Foreign Country Germany | Country of Citizenship Germany | |
| Post Office Address | Street Neehusenstr. 24 | City 21147 Hamburg | State or Country Germany | Zip Code |
| Dated: | | Inventor's Signature: | | |
| Full Name of Inventor | Last Name | First Name | Middle Name | |
| Residence & Citizenship | City | State or Foreign Country | Country of Citizenship | |
| Post Office Address | Street | City | State or Country | Zip Code |
| Dated: | | Inventor's Signature: | | |
| Full Name of Inventor | Last Name | First Name | Middle Name | |
| Residence & Citizenship | City | State or Foreign Country | Country of Citizenship | |
| Post Office Address | Street | City | State or Country | Zip Code |
| Dated: | | Inventor's Signature: | | |
| Full Name of Inventor | Last Name | First Name | Middle Name | |
| Residence & | City | State or Foreign Country | Country of Citizenship | |
| Citizenship | | | State or Country | Zip Code |

First Name

City

State or Foreign Country

Last Name

City

Street

Full Name of Inventor

Citizenship
Post Office Address

Residence &

TTORNEY'S DOCKET NO .: **PHNL010069 US**

As a below named inventor, I hereby declare that's

My residence, post office address and citizenship streas stated below next to my name.

I believe I am the original, first and sole inventor (if only the name is listed below) or an original, first joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "Met∩od of manufacturing a semiconductor device and a semiconductor device obtained by means of said method" the specification of which (check one)

LARATION and POWER OF

is attached hereto.

was filed on 05 February 2002

as Application Serial No. 10/067425

(if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by the amendment(s) referred to above.

I acknowledge the duty to disclose information which is material to patentability of this application in accordance with Title 37,

Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION(S)

| COUNTRY | APP. NUMBER | DATE OF FILING (DATE, MONTH, YEAR) | PRIORITY CLAIMED UNDER 35 U.S.C. 119 | |
|---------|-------------|---------------------------------------|---|--|
| Europe | 01200496.6 | 9 February 2001 | YES | |
| | | | | |

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35 United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1,56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

PRIOR UNITED STATES APPLICATION(S)

| APPLICATION SERIAL NUMBER | FILING DATE | STATUS (PATENTED, PENDING, ABANDONED) |
|---------------------------|-------------|---------------------------------------|
| | | |

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

Jack E. Haken, Reg. No. 26,902 Michael E. Marion, Reg. No. 32,266 Edward M. Blocker, Reg. No. 30,245

SEND CORRESPONDENCE TO: Corporate Patent Counsel;

U.S. Philips Corporation;

580 White Plains Road; Tarrytown, NY 10591

DIRECT TELEPHONE CALLS TO:

(name and telephone No.)

(914) 332-0222

| Dated: | | Inventor's Signature: | | |
|----------------------------|-----------------------------|--|--|----------|
| Full Name of Inventor | Last Name VAN VEEN | First Name Nicolaas | Middle Name Johannes Anthonius | |
| Residence & Citizenship | City Eindhoven | State or Foreign Country The Netherlands | Country of Citizenship The Netherlands | |
| Post Office Address | Street Prof. Holstlaan 6 | City 5656 AA Eindhoven | State or Country The Netherlands | Zip Code |
| Dated: | | Inventor's Signature: | | |
| Full Name of Inventor | Last Name DE SAMBER | First Name | Middle Name Andre | |
| Residence & Citizenship | City Eindh ven | State or Foreign Country The Netherlands | Country of Citizenship Belgium | |
| Post Office Address | Street Prof. H Istlaan 6 | City 5656 AA Eindh ven | State or Country Th Netherlands | Zip Code |

| | 5 | ۱ | |
|---|---|---|--|
| (| 1 | b | |
| | _ | , | |

| Dated: 19 March | 2002 | Inventor's Signature: | 77 //1- | / |
|----------------------------|---------------------------|----------------------------------|--------------------------------|----------|
| · | | | - W1 | |
| Full Name of Inventor | Last Name WEISS | First Name Thomas | Middle Name | |
| Residence & Citizenship | City Hamburg | State or Foreign Country Germany | Country of Citizenship Germany | |
| Post Office Address | Street Neehusenstr. 24 | City 21147 Hamburg | State or Country Germany | Zip Code |
| Dated: | | Inventor's Signature: | | |
| Full Name of Inventor | Last Name | First Name | Middle Name | |
| Residence & Citizenship | City | State or Foreign Country | Country of Citizenship | |
| Post Office Address | Street | City | State or Country | Zip Code |
| Dated: | *** | Inventor's Signature: | | |
| Full Name of Inventor | Last Name | First Name | Middle Name | |
| Residence & Citizenship | City | State or Foreign Country | Country of Citizenship | |
| Post Office Address | Street | City | State or Country | Zip Code |
| Dated: | | Inventor's Signature: | | |
| Full Name of Inventor | Last Name | First Name | Middle Name | |
| Residence & Citizenship | City | State or Foreign Country | Country of Citizenship | |
| Post Office Address | Street | City | State or Country | Zip Code |
| Dated: | | Inventor's Signature: | | |
| Full Name of Inventor | Last Name | First Name | Middle Name | |
| Residence & Citizenship | City | State or Foreign Country | Country or Citizenship | |
| Post Office Address | Street | City | State or Country | Zip Code |